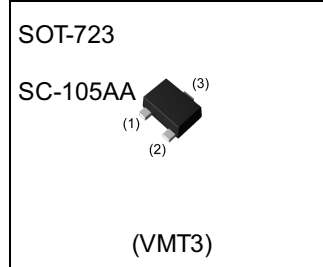


| Parameter | Value |
|-----------|--------------|
| V_{CEO} | 50V |
| I_C | 100mA |
| R_1 | 10k Ω |

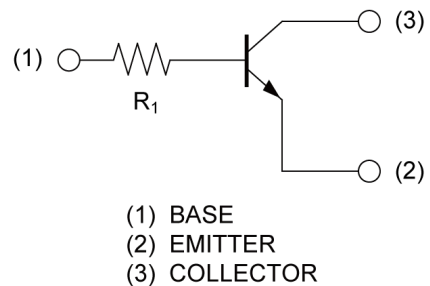
●Outline



●Features

- 1) Built-In Biasing Resistor
- 2) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary PNP Types: DTA114TM FHA

●Inner circuit



●Application

INVERTER, INTERFACE, DRIVER

●Packaging specifications

| Part No. | Package | Package size | Taping code | Reel size (mm) | Tape width (mm) | Basic ordering unit.(pcs) | Marking |
|--------------|----------------|--------------|-------------|----------------|-----------------|---------------------------|---------|
| DTC114TM FHA | SOT-723 (VMT3) | 1212 | T2L | 180 | 8 | 8000 | 04 |

● Absolute maximum ratings ($T_a = 25^\circ\text{C}$)

| Parameter | Symbol | Values | Unit |
|------------------------------|------------|-------------|------------------|
| Collector-base voltage | V_{CBO} | 50 | V |
| Collector-emitter voltage | V_{CEO} | 50 | V |
| Emitter-base voltage | V_{EBO} | 5 | V |
| Collector current | I_C | 100 | mA |
| Power dissipation | P_D^{*1} | 150 | mW |
| Junction temperature | T_j | 150 | $^\circ\text{C}$ |
| Range of storage temperature | T_{stg} | -55 to +150 | $^\circ\text{C}$ |

● Electrical characteristics ($T_a = 25^\circ\text{C}$)

| Parameter | Symbol | Conditions | Values | | | Unit |
|--------------------------------------|---------------|---|--------|------|------|------------|
| | | | Min. | Typ. | Max. | |
| Collector-base breakdown voltage | BV_{CBO} | $I_C = 50\mu\text{A}$ | 50 | - | - | V |
| Collector-emitter breakdown voltage | BV_{CEO} | $I_C = 1\text{mA}$ | 50 | - | - | V |
| Emitter-base breakdown voltage | BV_{EBO} | $I_E = 50\mu\text{A}$ | 5 | - | - | V |
| Collector cut-off current | I_{CBO} | $V_{CB} = 50\text{V}$ | - | - | 500 | nA |
| Emitter cut-off current | I_{EBO} | $V_{EB} = 4\text{V}$ | - | - | 500 | nA |
| Collector-emitter saturation voltage | $V_{CE(sat)}$ | $I_C = 10\text{mA}, I_B = 1\text{mA}$ | - | - | 300 | mV |
| DC current gain | h_{FE} | $V_{CE} = 5\text{V}, I_C = 1\text{mA}$ | 100 | 250 | 600 | - |
| Input resistance | R_1 | - | 7 | 10 | 13 | k Ω |
| Transition frequency | f_T^{*2} | $V_{CE} = 10\text{V}, I_E = -5\text{mA}, f = 100\text{MHz}$ | - | 250 | - | MHz |

*1 Each terminal mounted on a reference land.

*2 Characteristics of built-in transistor

●Electrical characteristic curves ($T_a = 25^\circ\text{C}$)

Fig.1 Grounded emitter propagation characteristics

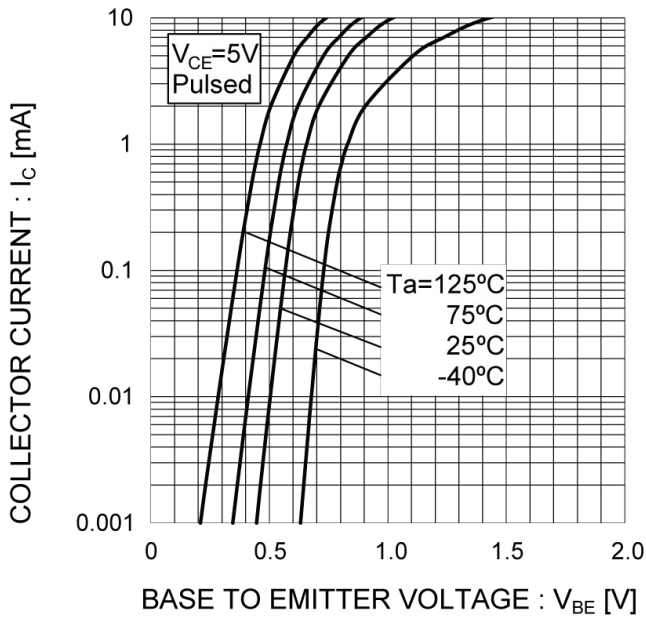


Fig.2 Grounded emitter output characteristics

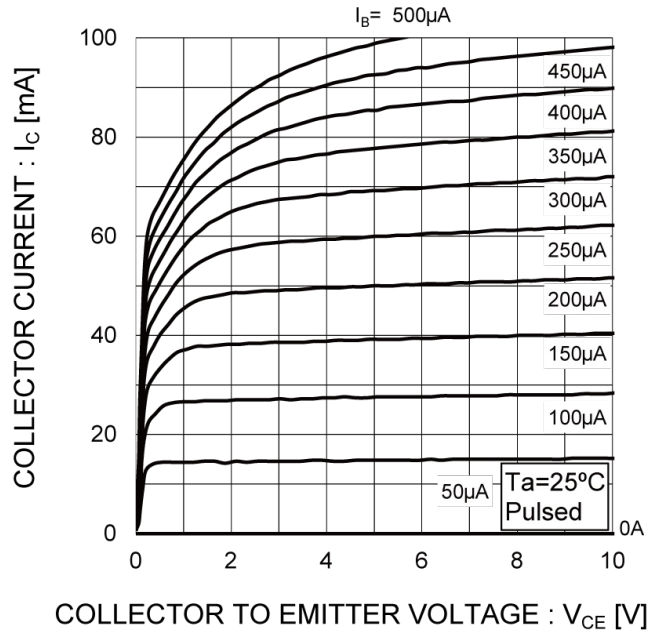


Fig.3 DC Current gain vs. Collector Current

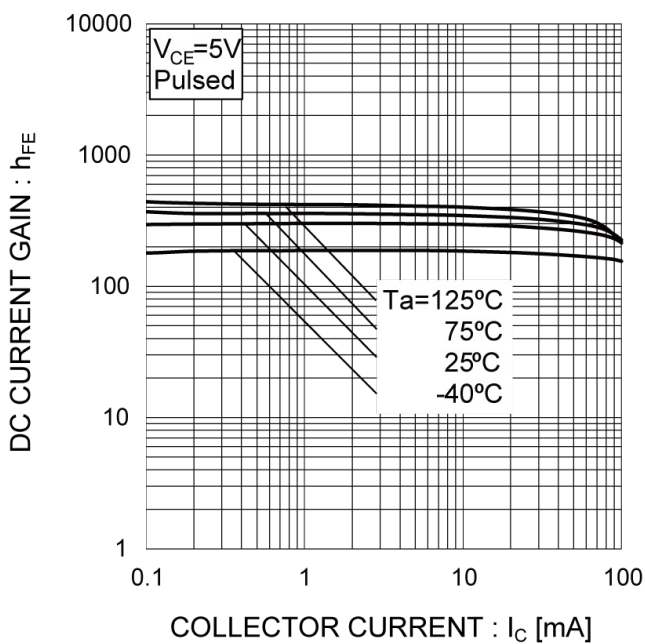
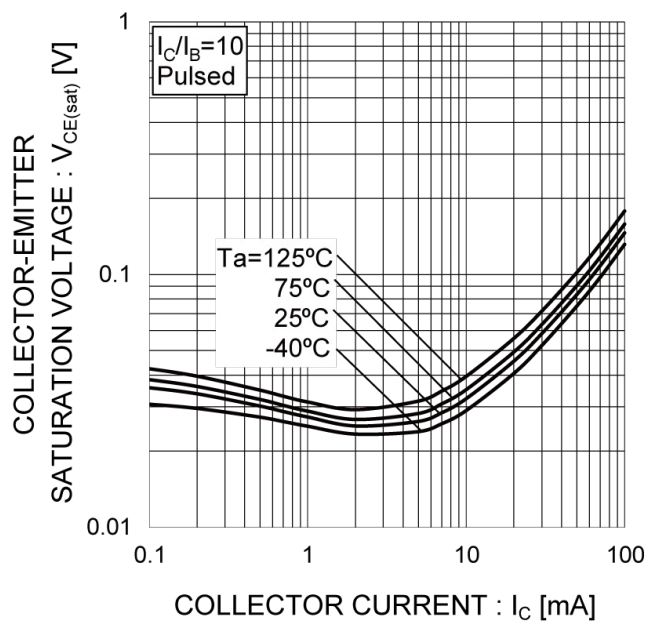


Fig.4 Collector-emitter saturation voltage vs. Collector Current



●Dimensions

SOT-723
SC-105AA
(VMT3)



Pattern of terminal position areas
[Not a pattern of soldering pads]

| DIM | MILIMETERS | | INCHES | |
|-----|------------|------|--------|-------|
| | MIN | MAX | MIN | MAX |
| A | 0.45 | 0.55 | 0.018 | 0.022 |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 |
| b | 0.17 | 0.27 | 0.007 | 0.011 |
| b1 | 0.27 | 0.37 | 0.011 | 0.015 |
| c | 0.08 | 0.18 | 0.003 | 0.007 |
| D | 1.10 | 1.30 | 0.043 | 0.051 |
| E | 0.70 | 0.90 | 0.028 | 0.035 |
| e | 0.40 | | 0.02 | |
| HE | 1.10 | 1.30 | 0.043 | 0.051 |
| L | 0.10 | 0.30 | 0.004 | 0.012 |
| Lp | 0.20 | 0.40 | 0.008 | 0.016 |
| x | - | 0.10 | - | 0.004 |

| DIM | MILIMETERS | | INCHES | |
|-----|------------|------|--------|-------|
| | MIN | MAX | MIN | MAX |
| b2 | - | 0.37 | - | 0.015 |
| b3 | - | 0.47 | - | 0.019 |
| e1 | 0.80 | | 0.031 | |
| I1 | - | 0.50 | - | 0.020 |

Dimension in mm/inches

Notice

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1. If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment ^(Note 1), aircraft/spacecraft, nuclear power controllers, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

| JAPAN | USA | EU | CHINA |
|-----------|-----------|------------|-----------|
| CLASS III | CLASS III | CLASS II b | CLASS III |
| CLASS IV | | CLASS III | |

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 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
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 - [h] Use of the Products in places subject to dew condensation
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6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
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8. Confirm that operation temperature is within the specified range described in the product specification.
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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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